**IEEE P802.19**

**Wireless Coexistence**

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| Project | IEEE P802.19 Wireless Coexistence WG | |
| Title | **July 2017 WG Minutes** | |
| Date Submitted | July 18, 2017 | |
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| Re: | [] | |
| Abstract | [] | |
| Purpose | [] | |
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**Monday July 10, 2017**

WG chair called the meeting to order at 4:02 PM.

Chair reviewed the agenda. The WG unanimously approved the agenda, document 802.19-17/0054r2.

Chair read the IEEE Patent Policy slides. There were no responses to the call for potentially essential patent claims.

Chair read the IEEE 802 Participation slides.

Motion to approve the minutes from the May meeting, document 802.19-17/50r0, passed without opposition.

The chair reviewed the Opening Report, document 802.19-17/0061r0

The TG1a chair presented the TG1a opening report, document 802.19-17/0060r0

The TG2 vice chair presented the TG2 opening report, document 802.19-17/0056r0

802.15 Liaison notified the WG that there has not been any update to the recent coexistence assurance (CA) documents.

Andrew Myles presented document 802.19-17/62r1

Discussed liaisons generation regarding 802.11/LAA coexistence. There is currently no plan for additional liaisons to 3GPP on this topic. 802.11 Coex SC chair said that the standing committee may prepare liaisons to ETSI BRAN. Everyone agreed that it is within scope for the Coex SC to prepare such liaisons which can be sent directly by 802.11 WG or the 802 EC.

WG agreed to cancel the Wednesday PM2 meeting since there were no agenda items for that meeting.

The WG recessed at 4:57 PM.

**Thursday July 13, 2017**

Chair called meeting to order at 4:02 PM.

WG Vice Chair volunteered to act as the liaison from 802.11

TG1a chair presented the TG1a closing report, document 802.19-17/70r0

**Motion**

Motion to approve the minutes from the July 2017 TG1a meeting, DCN 19-17/0069r0

Passed without objection

**Motion**

Confirm CSD for IEEE P802.19.1a in DCN ec-15/0074r1

Move: N. Sato (on behalf of TG)

Second: T. Baykas

Y:7 /N:0 /A:0

Motion Passed

**Motion**

Request the 802 Executive Committee to approve forwarding IEEE P802.19.1a-D3.0 to IEEE-SA RevCom.

Move: N. Sato (on behalf of TG)

Second: H. Kang

Y:7 /N:0 /A:0

Motion Approved

TG2 vice chair presented the TG2 closing report, document 802.19-17/68r1. WG chair encouraged the TG vice chair to prepare a call for submission for the draft and to circulate a month before the September session.

802.15 Liaison said there was no update on CA documents.

There was no new business.

Meeting adjourned at 4:32 PM.

**Attendance**

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| Tuncer Baykas | Istanbul Medipol University |
| Radhakrishna Canchi | Kyocera International Inc. |
| Sho Furuichi | Sony Corporation |
| Guido Hiertz | Ericsson AB |
| Hyunduk Kang | Electronics and Telecommunications Research Institute (ETRI) |
| James Lansford | Qualcomm Incorporated |
| NARENDAR MADHAVAN | TOSHIBA Corporation |
| Alaa Mourad | BMW Group |
| Andrew Myles | Cisco Systems, Inc. |
| Stephen Palm | Broadcom Corporation |
| James Petranovich | ViaSat, Inc. |
| Demir Rakanovic | u-blox |
| Naotaka Sato | Sony Corporation |
| Stephen Shellhammer | Qualcomm Incorporated |
| Adrian Stephens | Intel Corporation |
| Takenori Sumi | Mitsubishi Electric Corporation |
| Dennis Sundman | Ericsson AB |
| Mineo Takai | Space-Time Engineering |
| HASSAN YAGHOOBI | Intel Corporation |
| Chunhui Zhu | Huawei Technologies Co. Ltd |